查询SN54ABT534供应商

捷多邦,专业PCB打合U54ABT534急SNF74ABT534A OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

SN54ABT534 ... J OR W PACKAGE

SN74ABT534A . . . DB, DW, N, OR PW PACKAGE

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- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per **JEDEC Standard JESD-17**
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$
- High-Drive Outputs (-32-mA IOH, 64-mA IOL)
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), Plastic (N) and Ceramic (J) DIPs, and Ceramic Flat (W) Package

description

These 8-bit flip-flops with 3-state outputs are designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight flip-flops are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK), the \overline{Q} outputs are set to the complement of the logic levels set up at the data (D) inputs.

	(TOF	VIE	W)	
0E [1Q [2			V _C C 8Q
1D [2D [4		18 17	8D 7D
2 <u>Q</u> 3Q	5 6] 7 <u>Q</u>] 6Q
3D [4D [7 8		14 13]6D]5D
4Q [9			5Q
GND [10		11]clk

SN54ABT534 ... FK PACKAGE (TOP VIEW)

€ IQ IQ 2018	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

OE does not affect the internal operations of the flip-flop. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT534 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT534A is characterized for operation from -40°C to 85°C.



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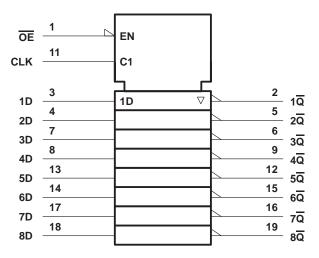
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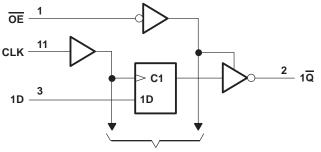
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FUNCTION TABLE (each flip-flop)								
INPUTS			OUTPUT					
OE	CLK	D	Q					
L	\uparrow	Н	L					
L	\uparrow	L	н					
L	H or L	Х	\overline{Q}_0					
н	Х	Х	Z					

logic symbol[†]



logic diagram (positive logic)



To Seven Other Channels

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC} Input voltage range, V _I (see Note 1) Voltage range applied to any output in the high	 –0.5 V to 7 V
Current into any output in the low state, I_{O} : SN	
· · · ·	
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I_{OK} ($V_O < 0$)	
Package thermal impedance, θ_{JA} (see Note 2)	
	 128°C/W
Storage temperature range, T _{stg}	

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.



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recommended operating conditions (see Note 3)

			SN54A	BT534	SN74AB	T534A	UNIT
				MAX	MIN	MAX	UNIT
VCC	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	/IH High-level input voltage		2		2		V
VIL	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	VCC	0	VCC	V
ЮН	High-level output current			-24		-32	mA
IOL	Low-level output current	put current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		5		5	ns/V
Т _А	Operating free-air temperature	ir temperature		125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T _A = 25°C			SN54A	BT534	SN74AB	UNIT		
PARAMETER		TEST CONDITIONS			TYP†	MAX	MIN	MAX	MIN	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lj = -18 mA				-1.2		-1.2		-1.2	V
	V _{CC} = 4.5 V,	I _{OH} = -3 mA		2.5			2.5		2.5		
Maria	V _{CC} = 5 V,	I _{OH} = -3 mA		3			3		3		V
VOH		I _{OH} = -24 m/	ł	2			2				v
	V _{CC} = 4.5 V	$I_{OH} = -32 \text{ m/}$	ł	2*					2		
		I _{OL} = 48 mA				0.55		0.55			V
VOL	V _{CC} = 4.5 V	I _{OL} = 64 mA				0.55*				0.55	v
V _{hys}		•			100						mV
lı -	V _{CC} = 5.5 V,	$V_{I} = V_{CC} \text{ or } C$	GND			±1		±1		±1	μΑ
IOZH	V _{CC} = 5.5 V,	V _O = 2.7 V				10‡		10‡		10‡	μΑ
IOZL	V _{CC} = 5.5 V,	V _O = 0.5 V				-10‡		-10‡		-10‡	μΑ
loff	V _{CC} = 0,	$V_{I} \text{ or } V_{O} \leq 4.5$	5 V			±100				±100	μΑ
ICEX	V _{CC} = 5.5 V,	V _O = 5.5 V	Outputs high			50		50		50	μΑ
١ _O §	V _{CC} = 5.5 V,	V _O = 2.5 V		-50	-100	-180‡	-50	-180‡	-50	-180‡	mA
			Outputs high		1	250		250		250	μΑ
ICC	$V_{CC} = 5.5 V, I_{C}$ $V_{I} = V_{CC} \text{ or } G$		Outputs low		24	30		30		30	mA
	vI = vCC or GIAD		Outputs disabled		0.5	250		250		250	μΑ
∆I _{CC} ¶	V_{CC} = 5.5 V, One input at 3.4 V, Other inputs at V_{CC} or GND				1.5		1.5		1.5	mA	
Ci	V _I = 2.5 V or 0.5 V			3.5						pF	
Co	V _O = 2.5 V or (0.5 V			6.5						pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.

[†] All typical values are at $V_{CC} = 5$ V.

[‡] This data sheet limit may vary among suppliers.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

I This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

					SN54ABT534				
				V _{CC} = 5 V, T _A = 25°C		МАХ	UNIT		
			MIN	MAX			L		
fclock	Clock frequency			125		125	MHz		
tw	Pulse duration	CLK high or low	3.5		3.5		ns		
t _{su}	Setup time, data before CLK [↑]	High or low	1.6		1.6		ns		
th	Hold time, data after CLK↑	High or low	1.6		1.6		ns		

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

				SN74AE	3T534A		
			V _{CC} = T _A = 2	= 5 V, 25°C	MIN	МАХ	UNIT
			MIN	MAX			L
fclock	Clock frequency			125		125	MHz
tw	Pulse duration	CLK high or low	3.5		3.5		ns
t _{su}	Setup time, data before CLK↑	High or low	1.6		1.6		ns
th	Hold time, data after CLK↑	High or low	2†		2†		ns

[†] This data sheet limit may vary among suppliers.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

				SN	54ABT5	34		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, T _A = 25°C			MIN MAX		UNIT
			MIN	TYP	MAX			
fmax			125	175		125		MHz
^t PLH	CLK	ā	2.6	4.5	6.1	2.6	7	ns
t _{PHL}		Q	3.4	5.5	6.7	3.4	7.9	115
^t PZH	OE	Q	1	3.4	5.2	1	5.8	ns
tPZL	OE	Q	2.6	4	5.8	2.6	7	115
^t PHZ	OE	ā	2.4	4.7	6.6	2.4	7.6	ns
tPLZ	UE	Q	2.3	3.8	5.8	2.3	6.8	115

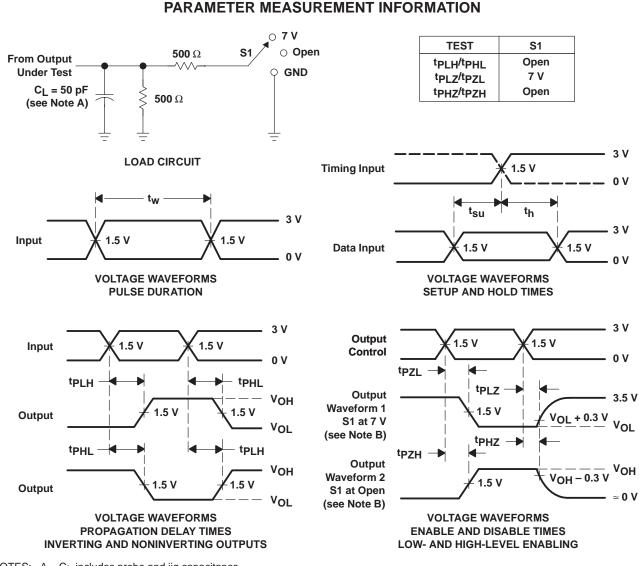
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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

				SN7	4ABT53	4A		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V(Т/	CC = 5 V A = 25°C	/, ;	MIN	МАХ	UNIT
			MIN	TYP	MAX			
fmax			125	175		125		MHz
^t PLH	CLK	ā	2.6	4.5	5.9	2.6	6.7	ns
^t PHL		Q	3.4	5.5	6.7	3.4	7.6	115
^t PZH	OE	Q	1	3.4	4.2	1	5	ns
tPZL	OE	Q	2.6	4	5.8	2.6	6.8	115
^t PHZ	OE	ā	2.4	4.7	6.6	2.4	7.3	ns
tPLZ	UE	Q	2.3	3.8	5.8	2.3	6.5	115



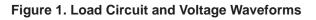
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NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.

D. The outputs are measured one at a time with one transition per measurement.





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